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## **Amendments to the Claims:**

This listing of claims will replace the listing of claims in the application.

## **LISTING OF CLAIMS:**

- 1. (currently amended) A Method method of fixing a power light-emitting diode

  (1) having a metallic base (2) to a metallic heat-radiating element (3), characterised by the

  fact that comprising the step of laser spot welding the base (2) of the light-emitting diode

  is fixed to the radiating element (3) by laser spot welding (11).
- 2. (currently amended) A Method method according to Claim 1, eharacterised by he fact that wherein the radiating element (3) is coated with a layer (6) of a metal, able to absorb the energy of a laser light.
- 3. (currently amended) A Method method according to Claim 1, characterised by he fact that wherein each welding spot has a centre and wherein the centres of the welding spots (11) are distributed substantially regularly over a contour parallel to the external perimeter of the base.
- 4. (currently amended) A Method method according to Claim 1, characterised by he fact that wherein the welding spots (11) are produced in the vicinity of the external perimeter of the base (2).
- 5. (currently amended) An Indicating indicating or lighting device for a car, comprising a power light-emitting diode whose having a base, mainly made from copper, which is fixed to a metallic heat-radiating element, for example made from copper, eharacterised by the fact that wherein the base (2) of the diode is fixed by laser spot welding (11) to the radiating element (3).

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- 6. (currently amended) A Device device according to Claim 5, characterised by the fact wherein the radiating element (3) is covered with a layer (C) of a metal for absorbing the laser radiation, for example a layer of nickel.
- 7. (currently amended) A Device device according to Claim 5, characterised by the fact that wherein each welding spot has a centre and wherein the centres of the welding spots (11) are distributed substantially regularly over a contour parallel to the external perimeter of the base.
- 8. (currently amended) A Device device according to Claim 7, eharacterised by the fact that wherein the welding spots (11) are distributed elese adjacent to the external perimeter of the base (2).
- 9. (currently amended) A Device device according to Claim 5, characterised by the fact that the means (B) of centring the base (2) of the diode are provided on the heat-radiating element (3) and comprise comprising projections produced in on the radiating element (3) for centering the base of the diode.
  - 10. (currently amended) <u>A Device device</u> according to Claim 5, characterised by the fact that wherein the electrodes (1a, 1b) of the diode are laser spot welded to conductive lugs.
  - 11. (currently amended) A Device device according to Claim 5, eharacterised by the fact that wherein the heat-radiating element (3) to which the base (2) of the light-emitting diode is fixed is attached to an insulating support (4) situated on the opposite side to the diode with respect to the radiating element, this said insulating support (4) comprising electrical connection lugs (9a, 9b; 19a, 19b), each electrode (1a, 1b) of the diode being connected respectively to a lug, the said-insulating support (4) comprising openings (5; 14) in line with the base and openings (6a, 6b; 15a, 15b) in line with the electrodes of the diode for passage of the laser welding beam.

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- 12. (currently amended) A Device device according to Claim 11, characterised by the fact that wherein the connecting lugs (9a, 9b) are situated on the side of the insulating support (4) turned disposed towards the radiating element (3).
- 13. (currently amended) A Device device according to Claim 11, eharacterised by the fact that wherein the connecting lugs (15a, 15b) are situated on the side of the insulating support (4) opposite to the heat-radiating element (3) and the connection between each connecting lug and the corresponding electrode of the diode is effected through a window (15a, 15b) provided in the insulating support (4) and another window (13a, 13b) provided in the radiating element.
- 14. (currently amended) A Device device according to Claim 5, characterised by
  the fact that wherein the heat-radiating element (3) to which the base (2) of the lightemitting diode is fixed is attached to an insulating support (4) situated on the same side as
  the diode (2) with respect to the heat radiator (3), an opening (14) being provided in the
  insulating support (4) in line with the base (2) of the light-emitting diode for its housing and
  its coming into contact with the radiator, and openings (15a, 15b) being provided also-for
  the electrodes.
  - 15. (currently amended) A Device device according to Claim 5, characterised by the fact that wherein the insulating support (4) is moulded onto the heat-radiating element (3), providing openings in line with the location of the base (2) of the light-emitting diode and for the electrodes.
- 16. (currently amended) <u>A Device device</u> according to Claim 5, <del>characterised in that</del> wherein the base <del>(2)</del> of the diode <del>(1)</del> is principally of copper.
  - 17. (currently amended) <u>A Device device</u> according to Claim 5, <del>characterised in that wherein the heat radiator (3) is principally composed of copper.</del>